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February 1995

LM1596/LM1496 Balanced Modulator-Demodulator

General Description

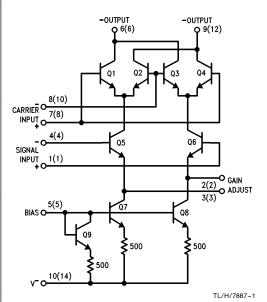
The LM1596/LM1496 are doubled balanced modulator-demodulators which produce an output voltage proportional to the product of an input (signal) voltage and a switching (carrier) signal. Typical applications include suppressed carrier modulation, amplitude modulation, synchronous detection, FM or PM detection, broadband frequency doubling and chopping.

The LM1596 is specified for operation over the -55°C to $+125^{\circ}\text{C}$ military temperature range. The LM1496 is specified for operation over the 0°C to $+70^{\circ}\text{C}$ temperature range.

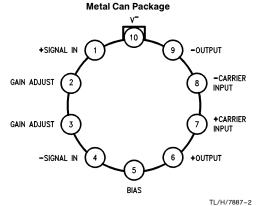
Features

- Excellent carrier suppression 65 dB typical at 0.5 MHz 50 dB typical at 10 MHz
- Adjustable gain and signal handling
- Fully balanced inputs and outputs
- Low offset and drift
- Wide frequency response up to 100 MHz

Schematic and Connection Diagrams



Numbers in parentheses show DIP connections.

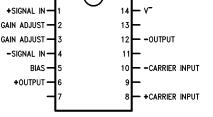


Top View

Note: Pin 10 is connected electrically to the case through the device substrate.

Order Number LM1496H or LM1596H See NS Package Number H08C

Dual-In-Line and Small Outline Packages



TL/H/7887

Order Number LM1496M or LM1496N See NS Package Number M14A or N14A

Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

500 mW Internal Power Dissipation (Note 1) Applied Voltage (Note 2) 30V Differential Input Signal ($V_7 - V_8$) $\pm\,5.0V$ Differential Input Signal ($V_4 - V_1$) $\pm (5 + I_5 R_0)V$ Input Signal ($V_2 - V_1, V_3 - V_4$) 5.0V Bias Current (I₅) 12 mA Operating Temperature Range LM1596 $\,-55^{\circ}\mathrm{C}$ to $\,+\,125^{\circ}\mathrm{C}$

LM1496 0°C to +70°C

Storage Temperature Range -65°C to +150°C Soldering Information

• Dual-In-Line Package Soldering (10 seconds) 260°C

• Small Outline Package

Vapor Phase (60 seconds) 215°C Infrared (15 seconds) 220°C

See AN-450 "Surface Mounting Methods and their effects on Product Reliability" for other methods of soldering surface mount devices.

$\textbf{Electrical Characteristics} \; (T_A = 25^{\circ}\text{C}, \, \text{unless otherwise specified, see test circuit})$

Parameter	Conditions	l	LM 159	6	LM1496			Units	
- arameter	Conditions	Min	Тур	Max	Min	Тур	Max	Jillis	
Carrier Feedthrough	$V_C = 60 \text{ mVrms sine wave}$		40			40		μVrms	
	$f_C = 1.0 \text{ kHz}$, offset adjusted $V_C = 60 \text{ mVrms}$ sine wave		140			140		μVrms	
	f _C = 10 kHz, offset adjusted							,	
	$V_C = 300 \text{ mV}_{pp} \text{ square wave}$			0.2		0.04	0.2	mVrms	
	$f_C = 1.0 \text{ kHz}$, offset adjusted $V_C = 300 \text{ mV}_{pp}$ square wave					20	150	mVrms	
	$f_C = 1.0 \text{ kHz}$, not offset adjusted		20	100		20	130	IIIVIIIIS	
Carrier Suppression	$f_S = 10 \text{ kHz}, 300 \text{ mVrms}$	50	65		50	65		dB	
	f _C = 500 kHz, 60 mVrms sine wave offset adjusted f _S = 10 kHz, 300 mVrms		50			50		dB	
	$f_C = 10 \text{ MHz}$, 60 mVrms sine wave offset adjusted		30			50		ub	
Transadmittance Bandwidth	$R_L = 50\Omega$		300			300		MHz	
	Carrier Input Port, $V_C = 60 \text{ mVrms}$ sine wave								
	f _S = 1.0 kHz, 300 mVrms sine wave Signal Input Port, V _S = 300 mVrms sine wave		80			80		MHz	
	$V_7 - V_8 = 0.5$ Vdc		00			00		IVII IZ	
Voltage Gain, Signal Channel	V _S = 100 mVrms, f= 1.0 kHz	2.5	3.5		2.5	3.5		V/V	
	$V_7 - V_8 = 0.5 \text{ Vdc}$	2.0	0.0		2.0	0.0		V, V	
Input Resistance, Signal Port	f = 5.0 MHz $ V_7 - V_8 = 0.5 \text{ Vdc} $		200			200		kΩ	
Input Capacitance, Signal Port	f = 5.0 MHz		2.0			2.0		pF	
0: 1 5 1 10 1 15 11	$V_7 - V_8 = 0.5 \text{ Vdc}$		40			40			
Single Ended Output Resistance			40			40		kΩ	
Single Ended Output Capacitance	f = 10 MHz		5.0			5.0		pF	
Input Bias Current	(I ₁ + I ₄)/2		12	25		12	30	μΑ	
Input Bias Current	$(I_7 + I_8)/2$		12	25		12	30	μΑ	
Input Offset Current	$(I_1 - I_4)$		0.7	5.0		0.7	5.0	μΑ	
Input Offset Current	$(I_7 - I_8)$		0.7	5.0		5.0	5.0	μΑ	
Average Temperature	$(-55^{\circ}C < T_{A} < +125^{\circ}C)$		2.0					nA/°C	
Coefficient of Input Offset Current	$\left (0^{\circ}C < T_{A} < +70^{\circ}C) \right $					2.0		nA/°C	
Output Offset Current	(l ₆ - l ₉)		14	50		14	60	μΑ	
Average Temperature	(-55°C < T _A < +125°C)		90					nA/°C	
Coefficient of Output Offset Current	$(0^{\circ}C < T_{A} < +70^{\circ}C)$					90		nA/°C	

Electrical Characteristics (T_A = 25°C, unless otherwise specified, see test circuit) (Continued)

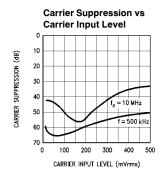
Parameter	Conditions	LM1596				Units		
		Min	Тур	Max	Min	Тур	Max	Units
Signal Port Common Mode Input Voltage Range	$f_S = 1.0 \text{ kHz}$		5.0			5.0		V _{p-p}
Signal Port Common Mode Rejection Ratio	$V_7 - V_8 = 0.5 \text{Vdc}$		-85			-85		dB
Common Mode Quiescent Output Voltage			8.0			8.0		Vdc
Differential Output Swing Capability			8.0			8.0		V _{p-p}
Positive Supply Current	$(I_6 + I_g)$		2.0	3.0		2.0	3.0	mA
Negative Supply Current	(I ₁₀)		3.0	4.0		3.0	4.0	mA
Power Dissipation			33			33		mW

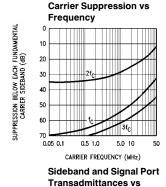
Note 1: LM1596 rating applies to case temperatures to +125°C; derate linearly at 6.5 mW/°C for ambient temperature above 75°C. LM1496 rating applies to case temperatures to +70°C.

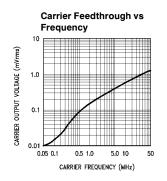
Note 2: Voltage applied between pins 6-7, 8-1, 9-7, 9-8, 7-4, 7-1, 8-4, 6-8, 2-5, 3-5.

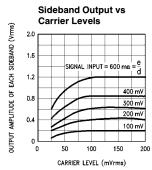
Note 3: Refer to rets1596x drawing for specifications of military LM1596H versions.

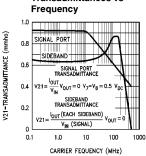
Typical Performance Characteristics

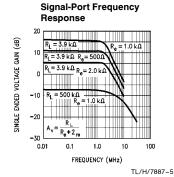






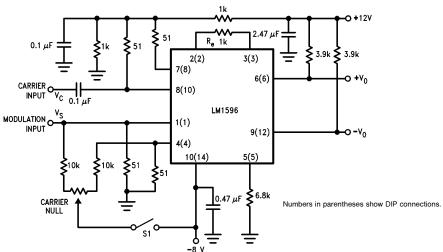






Typical Application and Test Circuit

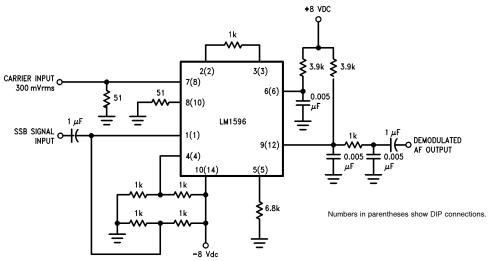
Suppressed Carrier Modulator



Note: S_1 is closed for "adjusted" measurements.

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SSB Product Detector

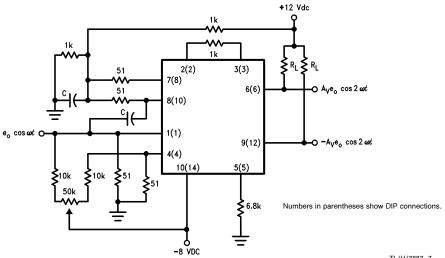


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This figure shows the LM1596 used as a single sideband (SSB) suppressed carrier demodulator (product detector). The carrier signal is applied to the carrier input port with sufficient amplitude for switching operation. A carrier input level of 300 mVrms is optimum. The composite SSB signal is applied to the signal input port with an amplitude of 5.0 to 500 mVrms. All output signal components except the desired demodulated audio are filtered out, so that an offset adjustment is not required. This circuit may also be used as an AM detector by applying composite and carrier signals in the same manner as described for product detector operation.

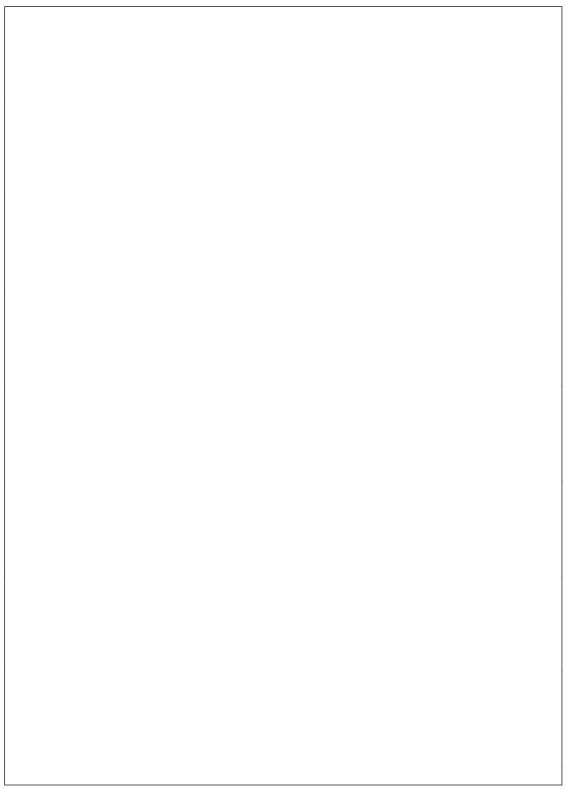
Typical Applications (Continued)

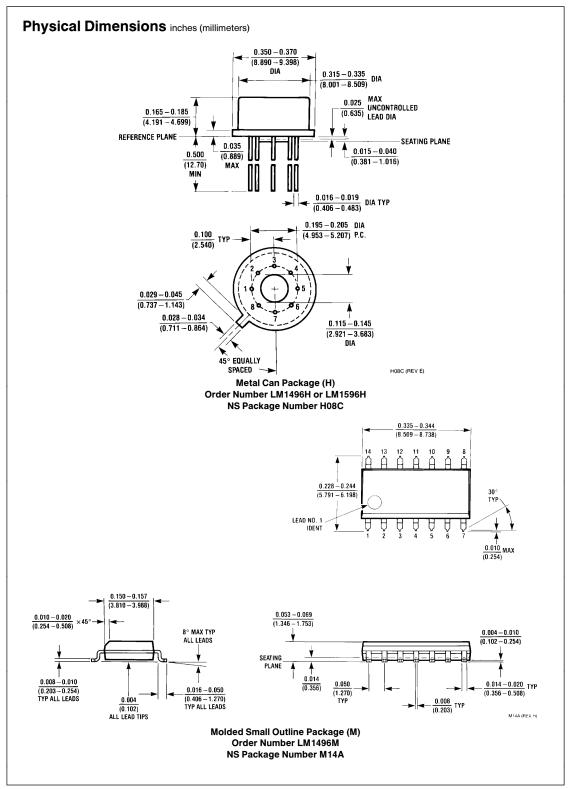
Broadband Frequency Doubler



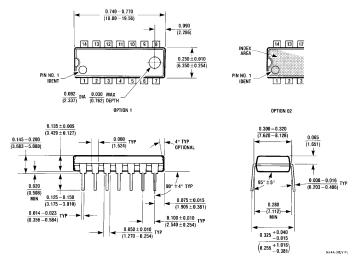
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The frequency doubler circuit shown will double low-level signals with low distortion. The value of C should be chosen for low reactance at the operating frequency. Signal level at the carrier input must be less than 25 mV peak to maintain operation in the linear region of the switching differential amplifier. Levels to 50 mV peak may be used with some distortion of the output waveform. If a larger input signal is available a resistive divider may be used at the carrier input, with full signal applied to the signal input.





Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number LM1496N NS Package Number N14A

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